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<b>Application Number</b>	<b>09/872,407</b>
<b>Filing Date</b>	<b>Jun 1, 2001</b>
<b>First Named Inventor</b>	<b>Carlos M. Batista</b>
<b>Art Unit</b>	<b>2121</b>
<b>Examiner Name</b>	<b>Not yet assigned</b>
<b>Attorney Docket No.</b>	<b>259/043; 21039-7024</b>

**U.S. PATENT DOCUMENTS**

[illegible]

## FOREIGN PATENT DOCUMENTS

[illegible]

**Examiner's  
Signature**

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